

STP7N105K5, STU7N105K5, STW7N105K5

N-channel 1050 V, 1.4 Ω typ., 4 A MDmesh™ K5
Power MOSFETs in TO-220, IPAK and TO-247 packages

Datasheet - production data

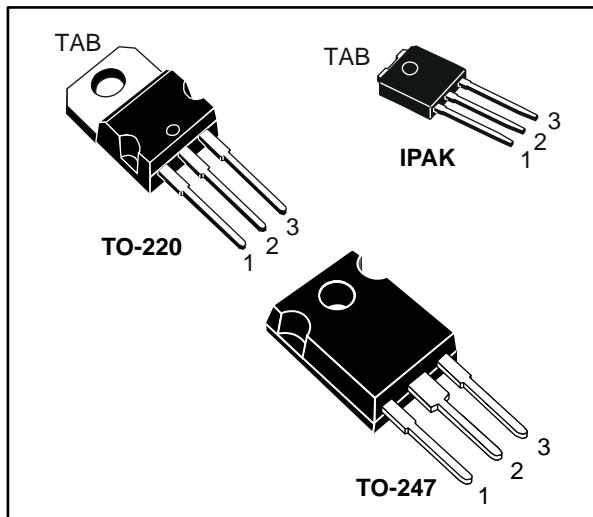


Figure 1: Internal schematic diagram

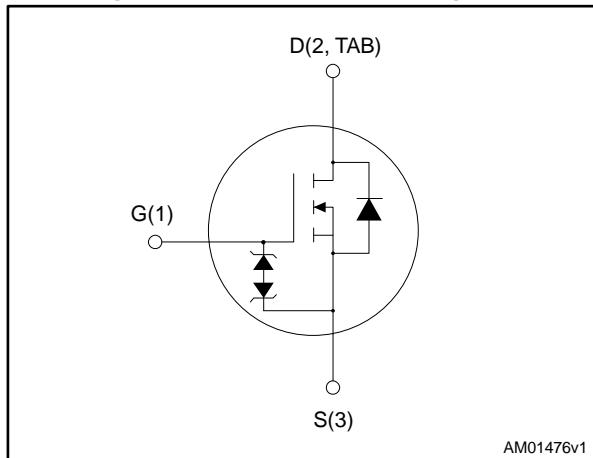


Table 1: Device summary

Order code	Marking	Package	Packaging
STP7N105K5	7N105K5	TO-220	Tube
STU7N105K5		IPAK	
STW7N105K5		TO-247	

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2.1 Electrical characteristics (curves)

Figure 2: Safe operating area for TO-220 and TO-247

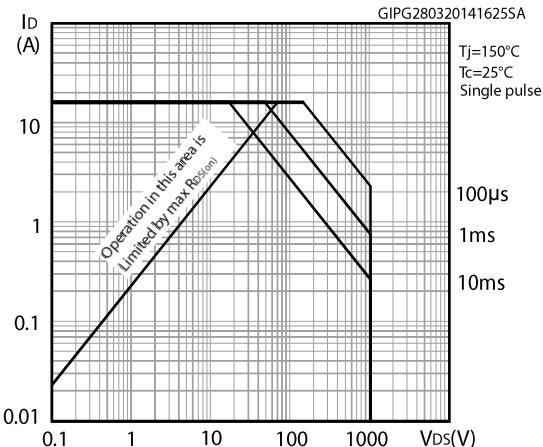


Figure 3: Thermal impedance for TO-220 and TO-247

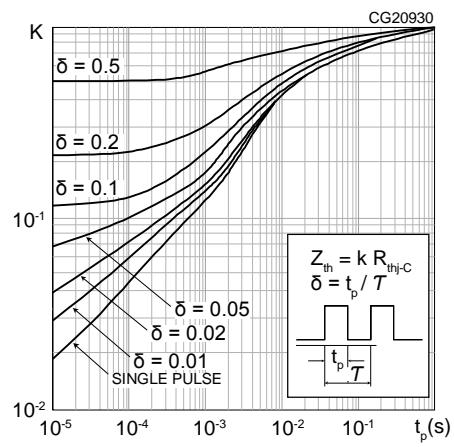


Figure 4: Safe operating area for IPAK

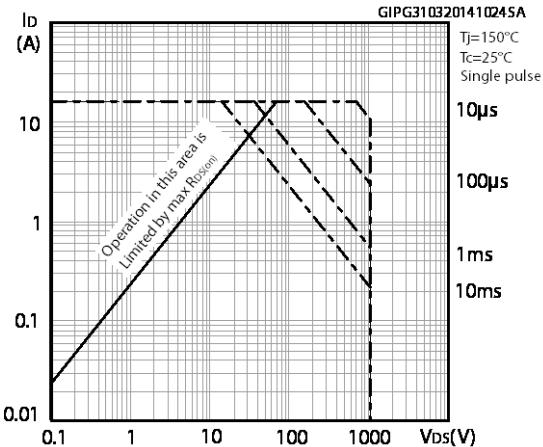


Figure 5: Thermal impedance for IPAK

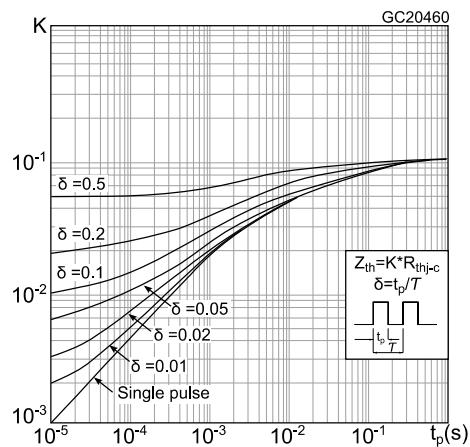


Figure 6: Output characteristics

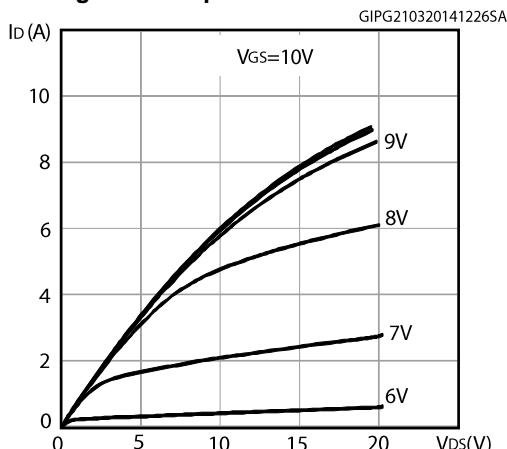


Figure 7: Transfer characteristics

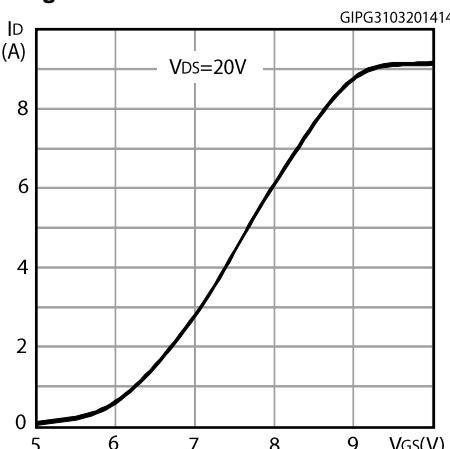
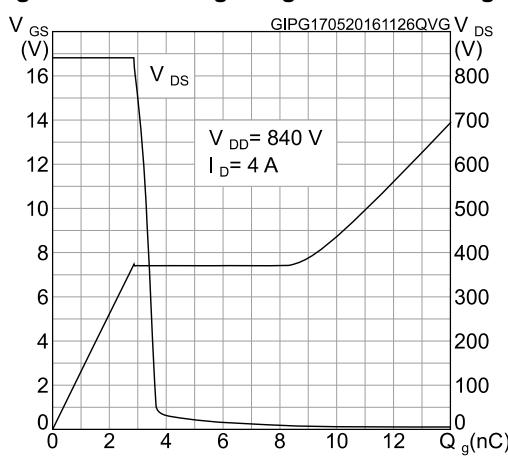
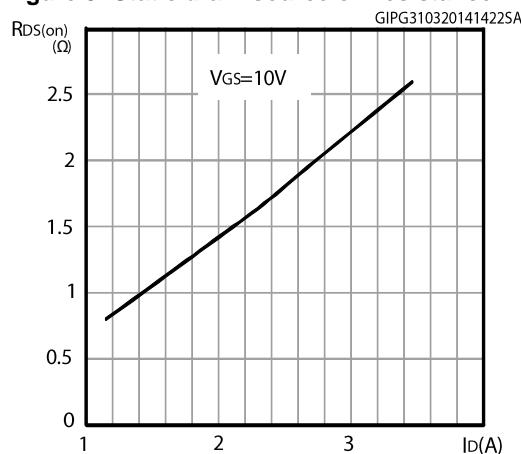
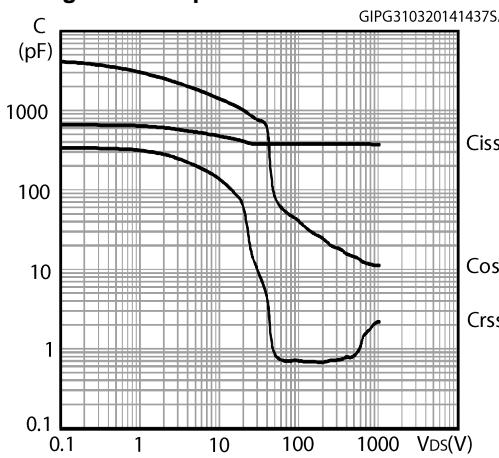
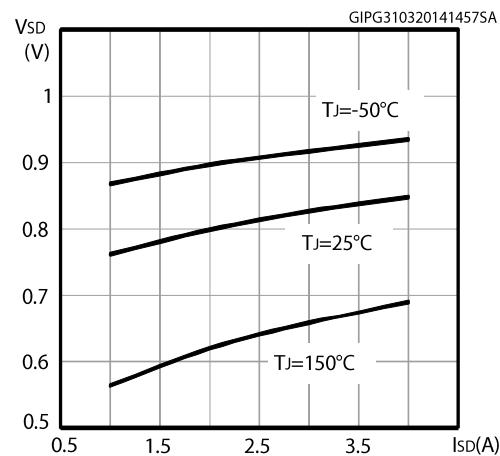
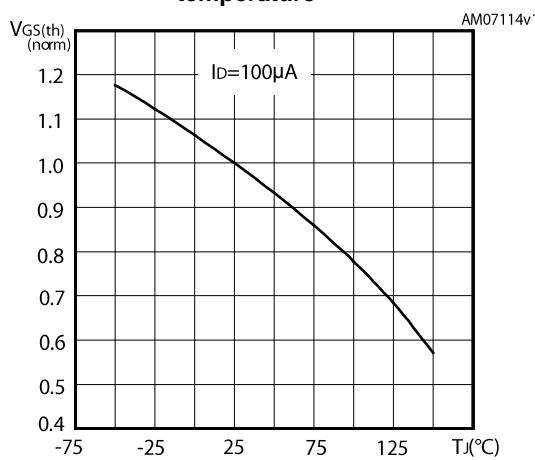
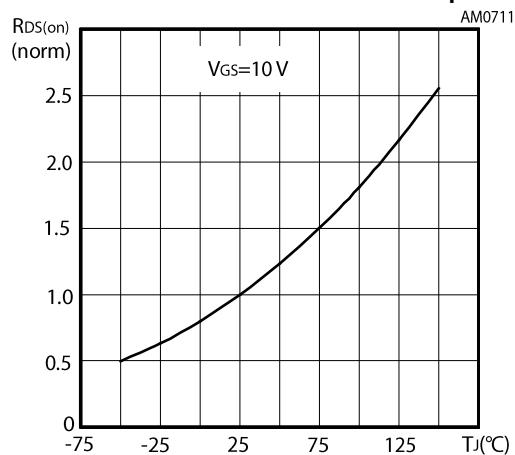


Figure 8: Gate charge vs gate-source voltage**Figure 9: Static drain-source on-resistance****Figure 10: Capacitance variations****Figure 11: Source-drain diode forward characteristics****Figure 12: Normalized gate threshold voltage vs temperature****Figure 13: Normalized on-resistance vs temperature**

Electrical characteristics

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Figure 14: Normalized V(BR)DSS vs temperature

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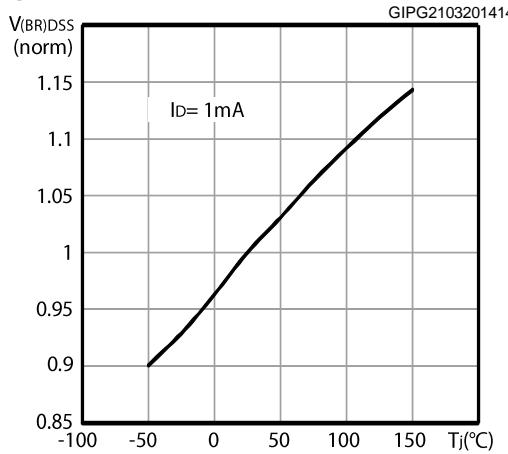


Figure 15: Maximum avalanche energy vs starting T_j

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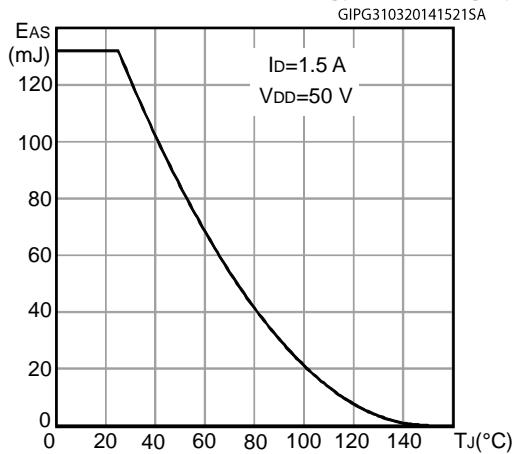
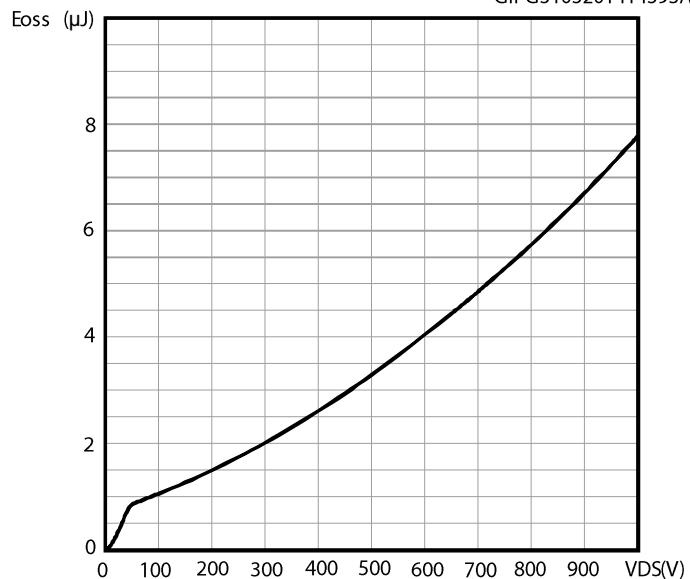


Figure 16: Output capacitance stored energy

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3 Test circuits

Figure 17: Test circuit for resistive load switching times

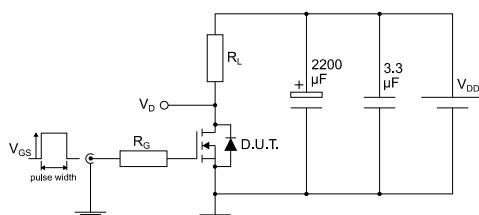


Figure 18: Test circuit for gate charge behavior

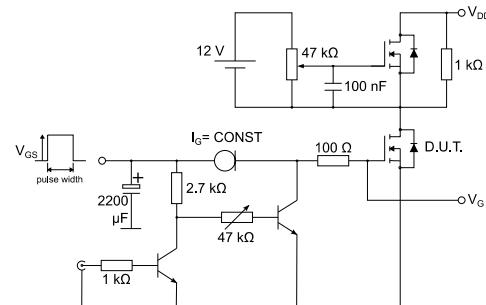


Figure 19: Test circuit for inductive load switching and diode recovery times

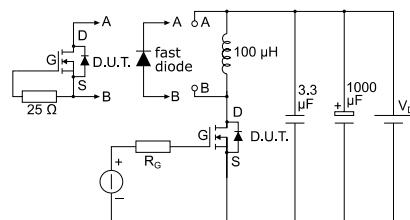


Figure 20: Unclamped inductive load test circuit

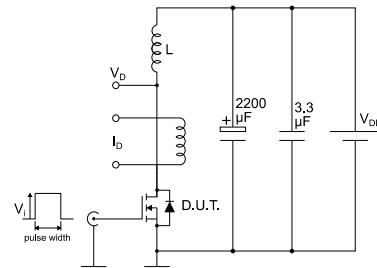


Figure 21: Unclamped inductive waveform

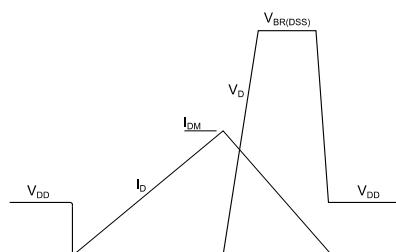
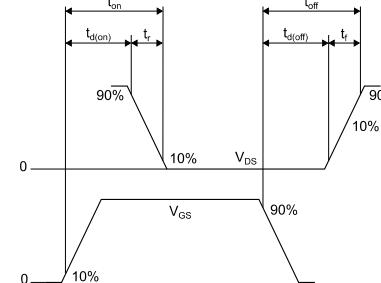


Figure 22: Switching time waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK® is an ST trademark.

4.1 TO-220 package information

Figure 23: TO-220 type A package outline

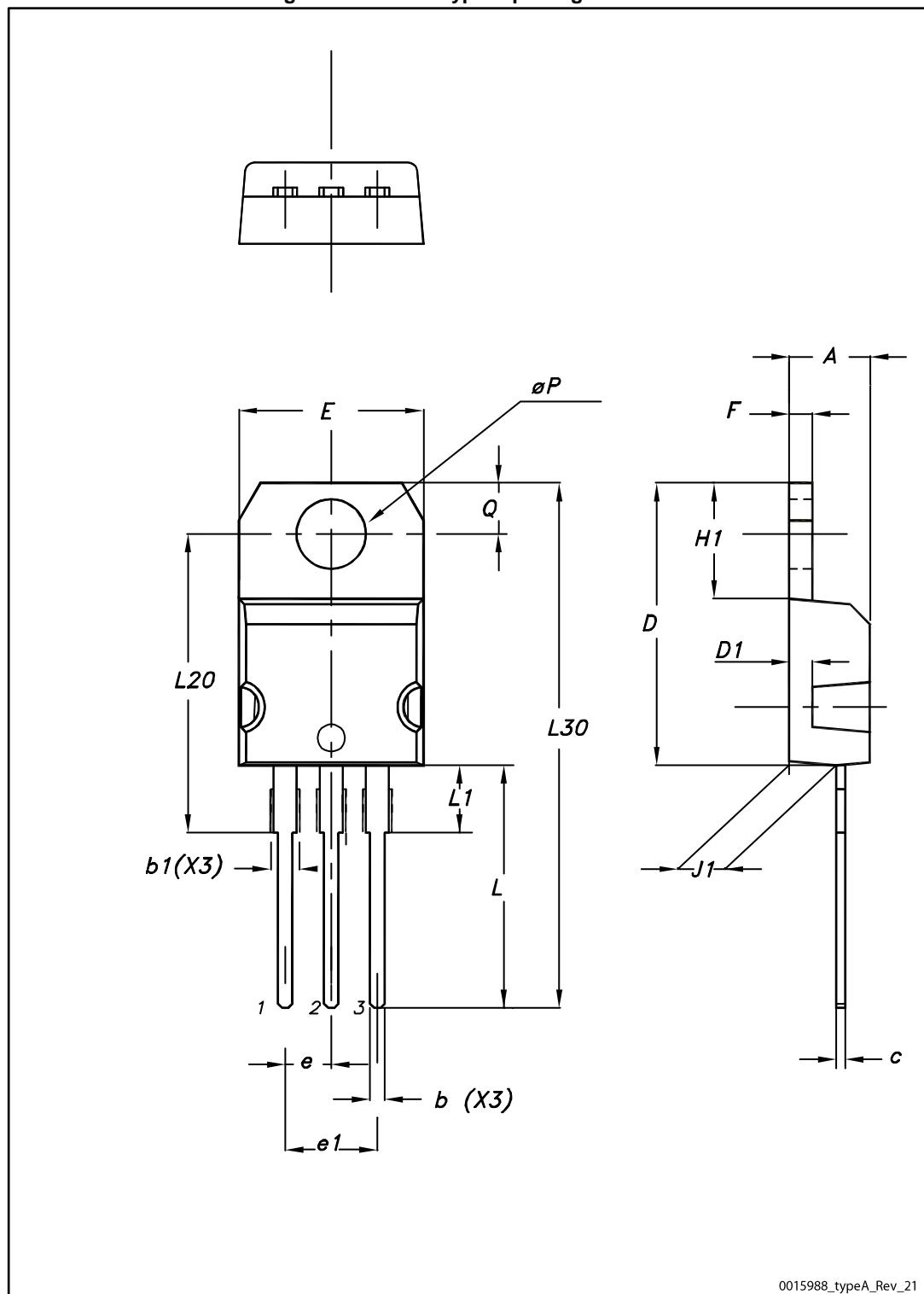


Table 9: TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

4.2 IPAK package information

Figure 24: IPAK (TO-251) type A package outline

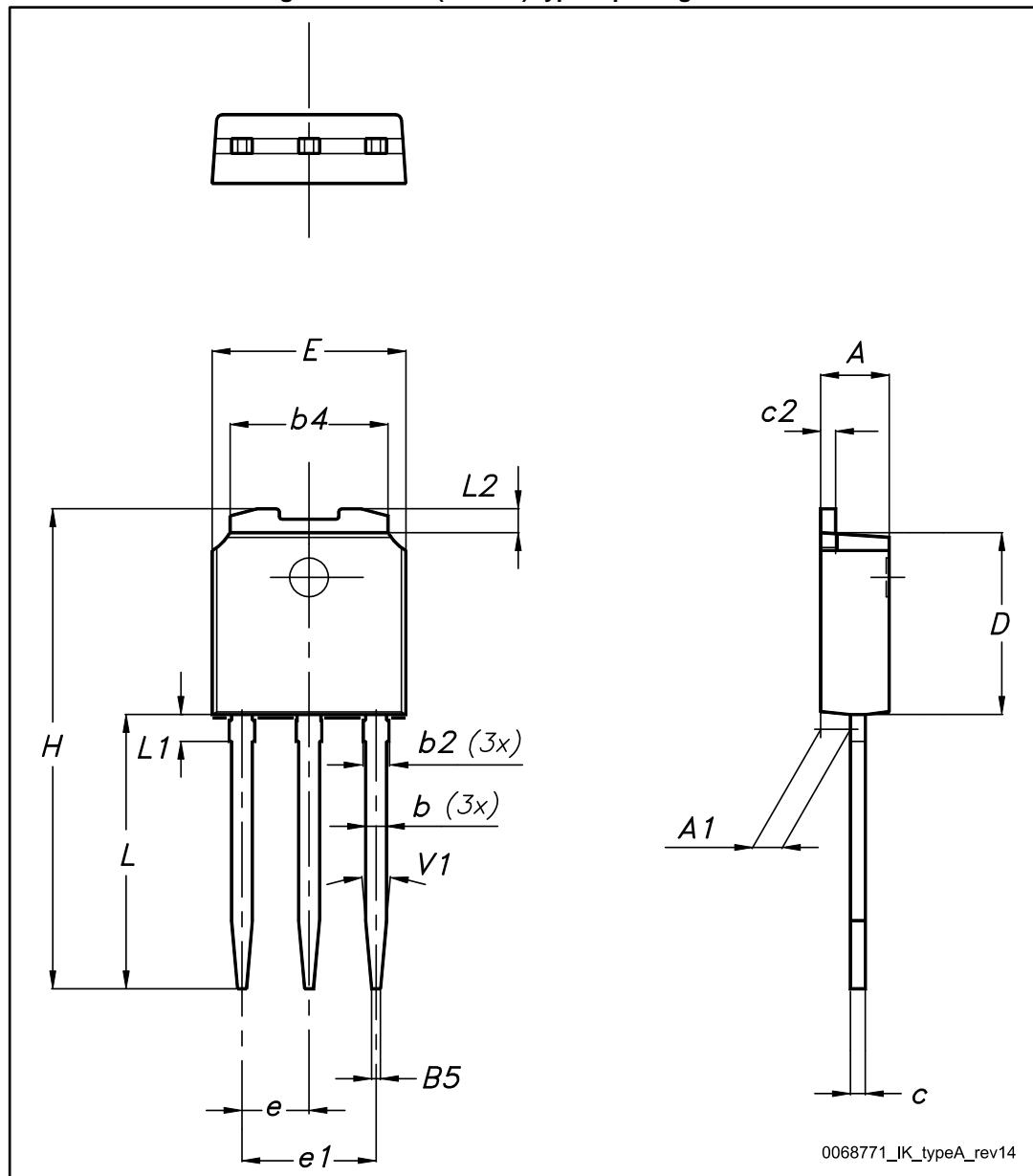


Table 10: IPAK (TO-251) type A package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
B5		0.30	
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
E	6.40		6.60
e		2.28	
e1	4.40		4.60
H		16.10	
L	9.00		9.40
L1	0.80		1.20
L2		0.80	1.00
V1		10°	

4.3 TO-247 package information

Figure 25: TO-247 package outline

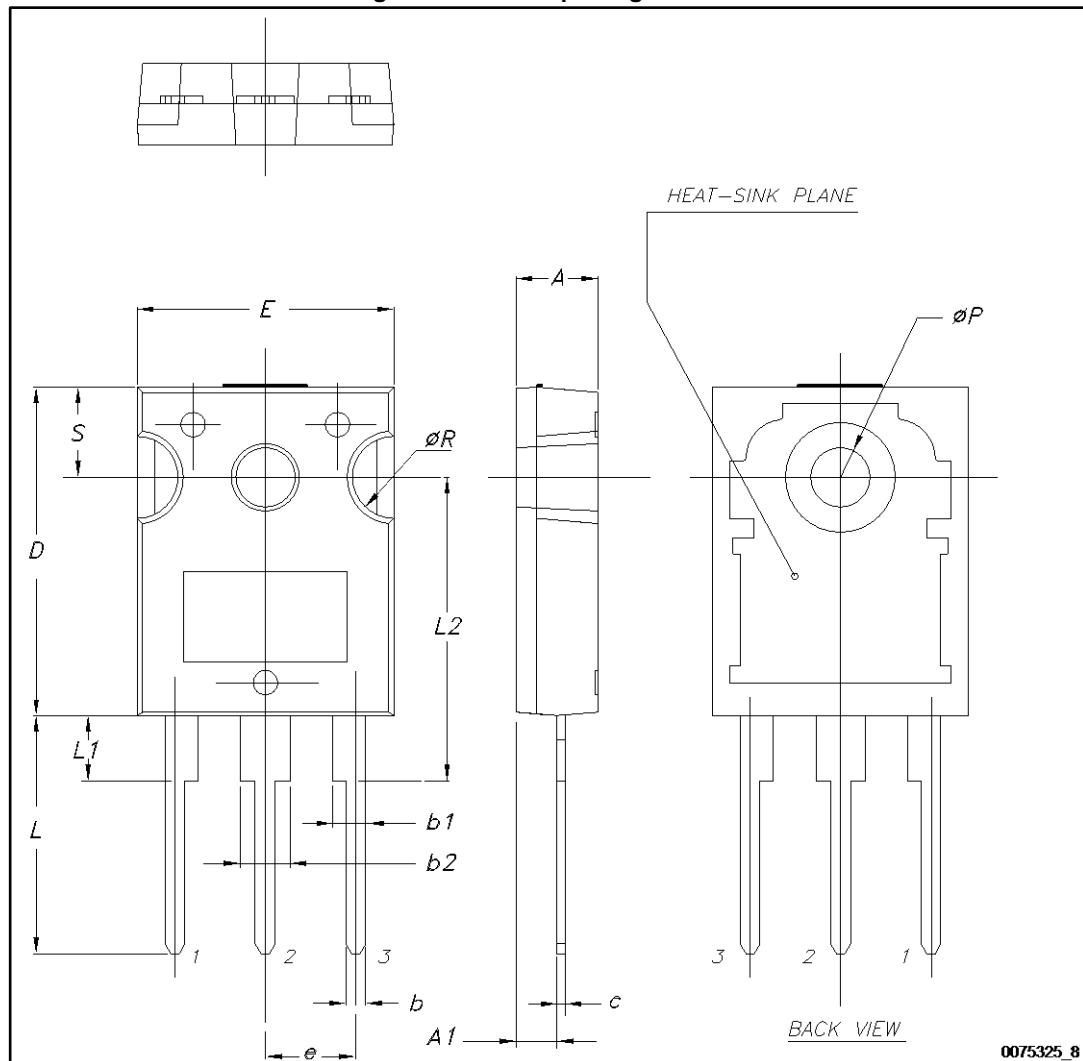


Table 11: TO-247 package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

5 Revision history

Table 12: Document revision history

Date	Revision	Changes
07-Apr-2014	1	First release.
17-Oct-2016	2	Updated Figure 8: "Gate charge vs gate-source voltage" and Table 5: "Dynamic" . Minor text changes.

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